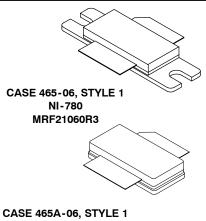
The RF MOSFET Line **RF Power Field Effect Transistors** N-Channel Enhancement-Mode Lateral MOSFETs

Designed for PCN and PCS base station applications with frequencies from 2.1 to 2.2 GHz. Suitable for W-CDMA, CDMA, TDMA, GSM and multicarrier amplifier applications.

- Typical W-CDMA Performance: 2140 MHz, 28 Volts 5 MHz Offset @ 4.096 MHz BW, 15 DTCH Output Power — 6.0 Watts Power Gain — 12.5 dB Drain Efficiency — 15%
- Internally Matched, Controlled Q, for Ease of Use
- High Gain, High Efficiency and High Linearity
- Integrated ESD Protection
- Designed for Maximum Gain and Insertion Phase Flatness
- Capable of Handling 10:1 VSWR, @ 28 Vdc, 2.11 GHz, 60 Watts CW Output Power
- Excellent Thermal Stability
- Characterized with Series Equivalent Large-Signal Impedance Parameters
- In Tape and Reel. R3 Suffix = 250 Units per 56 mm, 13 Inch Reel.



2170 MHz, 60 W, 28 V LATERAL N-CHANNEL RF POWER MOSFETs



NI-780S MRF21060SR3

MAXIMUM RATINGS

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Besca

Rating	Symbol	Value	Unit
Drain-Source Voltage	V _{DSS}	65	Vdc
Gate-Source Voltage	V _{GS}	-0.5, +15	Vdc
Total Device Dissipation @ T _C = 25°C Derate above 25°C	PD	180 0.98	Watts W/°C
Storage Temperature Range	T _{stg}	- 65 to +150	°C
Operating Junction Temperature	TJ	200	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.02	°C/W

ESD PROTECTION CHARACTERISTICS

Test Conditions	Class
Human Body Model	2 (Minimum)
Machine Model	M3 (Minimum)

NOTE - **CAUTION** - MOS devices are susceptible to damage from electrostatic charge. Reasonable precautions in handling and packaging MOS devices should be observed.

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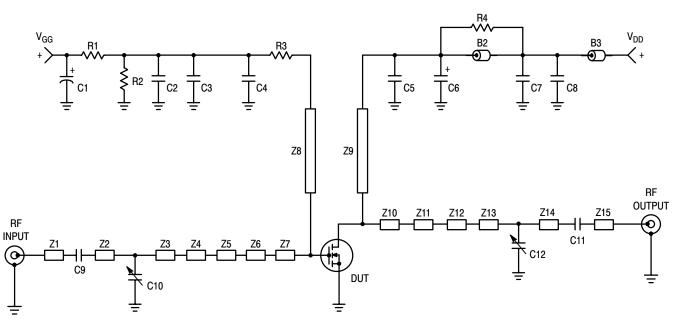


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ELECTRICAL CHARACTERISTICS ($T_C = 25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS				•	
Drain - Source Breakdown Voltage (V_{GS} = 0 Vdc, I _D = 10 μ Adc)	V _{(BR)DSS}	65	_	_	Vdc
Zero Gate Voltage Drain Current (V _{DS} = 28 Vdc, V _{GS} = 0 Vdc)	I _{DSS}	_		6	μAdc
Gate-Source Leakage Current (V _{GS} = 5 Vdc, V _{DS} = 0 Vdc)	I _{GSS}	_		1	μAdc
ON CHARACTERISTICS					
Gate Threshold Voltage (V _{DS} = 10 Vdc, I _D = 300 μAdc)	V _{GS(th)}	2	_	4	Vdc
Gate Quiescent Voltage (V _{DS} = 28 Vdc, I _D = 500 mAdc)	V _{GS(Q)}	2.5	3.9	4.5	Vdc
Drain-Source On-Voltage (V _{GS} = 10 Vdc, I _D = 2 Adc)	V _{DS(on)}	—	0.27	_	Vdc
Forward Transconductance $(V_{DS} = 10 \text{ Vdc}, I_D = 2 \text{ Adc})$	9fs	—	4.7	_	S
DYNAMIC CHARACTERISTICS					
Reverse Transfer Capacitance (1) $(V_{DS} = 28 \text{ Vdc}, V_{GS} = 0, f = 1 \text{ MHz})$	C _{rss}	—	2.7	—	pF
UNCTIONAL TESTS (In Motorola Test Fixture, 50 ohm system)					
Two-Tone Common-Source Amplifier Power Gain (V _{DD} = 28 Vdc, P _{out} = 60 W PEP, I _{DQ} = 500 mA, f = 2110 MHz and 2170 MHz, Tone Spacing = 100 kHz)	G _{ps}	11	12.5	_	dB
Two-Tone Drain Efficiency (V _{DD} = 28 Vdc, P _{out} = 60 W PEP, I _{DQ} = 500 mA, f = 2110 MHz and 2170 MHz, Tone Spacing = 100 kHz)	η	31	34	_	%
3rd Order Intermodulation Distortion (V_{DD} = 28 Vdc, P_{out} = 60 W PEP, I_{DQ} = 500 mA, f = 2110 MHz and 2170 MHz, Tone Spacing = 100 kHz)	IMD		-30	-28	dBc
Input Return Loss (V _{DD} = 28 Vdc, P _{out} = 60 W PEP, I _{DQ} = 500 mA, f = 2110 MHz and 2170 MHz, Tone Spacing = 100 kHz)	IRL		-12	_	dB
P _{out} , 1 dB Compression Point (V _{DD} = 28 Vdc, P _{out} = 60 W CW, f = 2170 MHz)	P1dB		60	_	W
Output Mismatch Stress (V_{DD} = 28 Vdc, P_{out} = 60 W CW, I_{DQ} = 500 mA, f = 2110 MHz, VSWR = 10:1, All Phase Angles at Frequency of Tests)	Ψ	No Degradation In Output Power Before and After Test			

(1) Part is internally matched both on input and output.



B2 - B3	Ferrite Beads, Fair Rite #2743019447	Z3	0.180″ x 0.100″ Microstrip
C1	10 μF, 50 V Electrolytic Chip Capacitor, Panasonic #ECEV1HV100R	Z4	0.152" x 0.293" Microstrip
C2, C7	1000 pF Chip Capacitors, ATC #100B102JCA500X	Z5	0.216" x 0.100" Microstrip
C3, C8	0.10 µF Chip Capacitors, Kemet #CDR33BX104AKWS	Z6	0.114" x 0.410" Microstrip
C4, C5	4.7 pF Chip Capacitors, ATC #100B4R7JCA500X	Z7	0.626" x 0.872" Microstrip
C6	22 μF, 35 V Tantalum Surface Mount Chip Capacitor, Sprague	Z8	1.050" x 0.050" Microstrip
C9, C11	9.1 pF Chip Capacitors, ATC #100B9R1JCA500X	Z9	0.830" x 0.050" Microstrip
C10	0.8 pF - 8.0 pF Variable Capacitor, Johanson Gigatrim	Z10	0.596" x 1.040" Microstrip
C12	0.4 pF - 4.5 pF Variable Capacitor, Johanson Gigatrim	Z11	0.186" x 0.315" Microstrip
R1	1 kΩ, 1/4 W Fixed Film Chip Resistor, 0.08″ x 0.13″	Z12	0.097" x 0.525" Microstrip
R2	560 kΩ, 1/4 W Fixed Film Chip Resistor, 0.08″ x 0.13″	Z13	0.353" x 0.138" Microstrip
R3	10 Ω, 1/4 W Fixed Film Chip Resistor, 0.08″ x 0.13″	Z14	0.112" x 0.080" Microstrip
R4	10 Ω, 1/4 W Fixed Film Chip Resistor, 0.08″ x 0.13″	Z15	0.722" x 0.080" Microstrip
Z1	0.743″ x 0.080″ Microstrip	Board	0.030" Glass Teflon [®] , Arlon
Z2	0.070" x 0.100" Microstrip		GX-0300-55-22, 2 oz Cu

Figure 1. MRF21060 Test Circuit Schematic

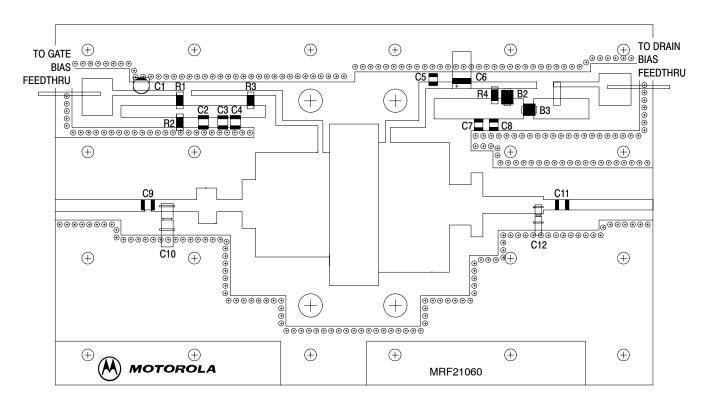
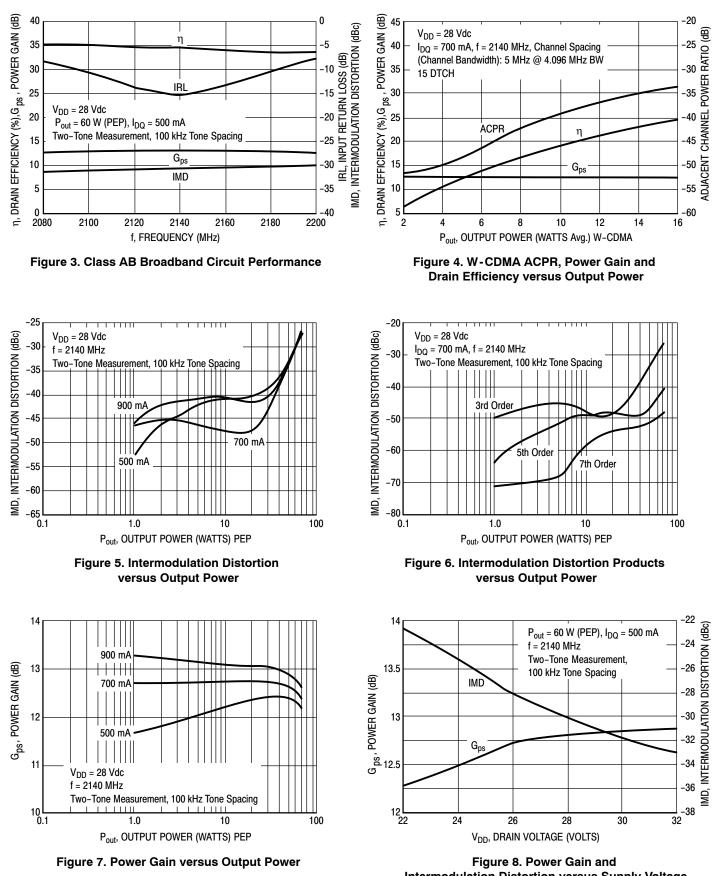


Figure 2. MRF21060 Test Circuit Component Layout

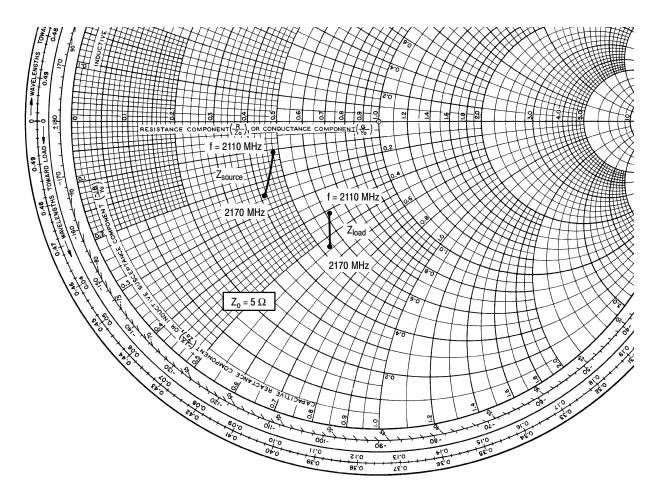
TYPICAL CHARACTERISTICS



Intermodulation Distortion versus Supply Voltage

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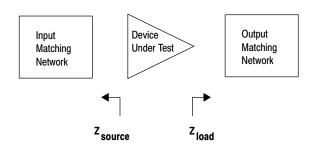


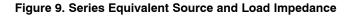
 V_{DD} = 28 V, I_{DQ} = 500 mA, P_{out} = 60 W PEP

f MHz	z_{source}	${\sf Z}_{\sf load}_{\Omega}$
2110	2.40 - j0.55	3.07 - j2.05
2140	2.26 - j0.87	2.89 - j2.38
2170	2.08 - j1.23	2.66 - j2.71

Test circuit impedance as measured from Z_{source} = gate to ground.

Test circuit impedance as measured Z_{load} = from drain to ground.

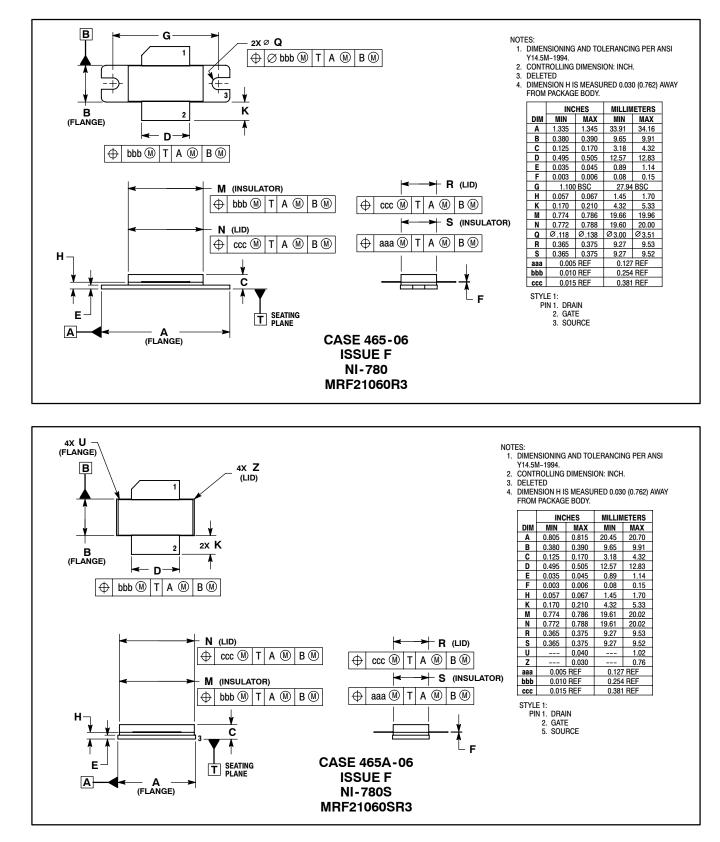




Freescale Semiconductor, Inc.

MRF21060R3 MRF21060SR3

PACKAGE DIMENSIONS



MOTOROLA RF DEVICE DATA

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